



STF16N65M5, STI16N65M5 STP16N65M5, STU16N65M5, STW16N65M5

N-channel 650 V, 0.230 Ω 12 A MDmesh™ V Power MOSFET
in TO-220FP, I²PAK, TO-220, IPAK, TO-247

Features

| Type | V _{DSS} @ T _{Jmax} | R _{DS(on)} max | I _D |
|------------|--------------------------------------|-------------------------|----------------|
| STF16N65M5 | | | |
| STI16N65M5 | | | |
| STP16N65M5 | 710 V | < 0.279 Ω | |
| STU16N65M5 | | | |
| STW16N65M5 | | | |

- Worldwide best R_{DS(on)}
- Higher V_{DSS} rating
- High dv/dt capability
- Excellent switching performance
- Easy to drive
- 100% avalanche tested

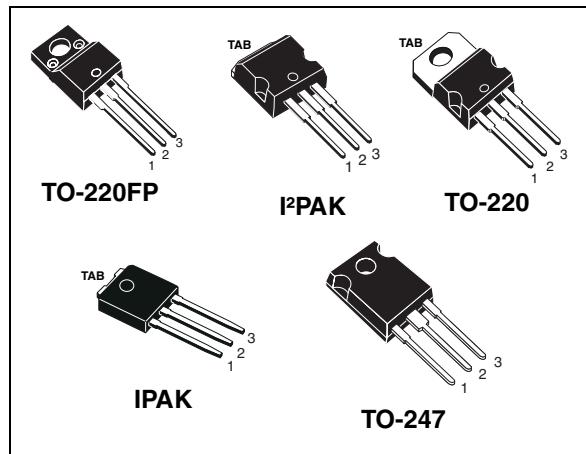
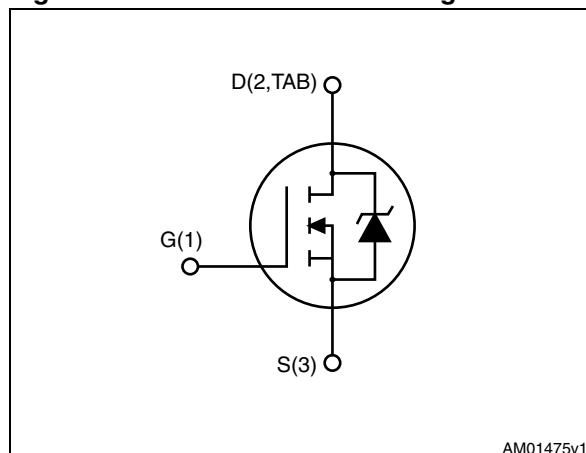


Figure 1. Internal schematic diagram



AM01475v1

Applications

- Switching applications

Description

These devices are N-channel MDmesh™ V Power MOSFETs based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESHTM horizontal layout structure. The resulting product has extremely low on-resistance, which is unmatched among silicon-based Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

Table 1. Device summary

| Order codes | Marking | Package | Packaging |
|-------------|---------|--------------------|-----------|
| STF16N65M5 | | TO-220FP | |
| STI16N65M5 | | I ² PAK | |
| STP16N65M5 | 16N65M5 | TO-220 | Tube |
| STU16N65M5 | | IPAK | |
| STW16N65M5 | | TO-247 | |

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1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | | Unit |
|----------------|---|--------------------|---|------------------|
| | | TO-220FP | TO-220, I ² PAK, IPAK, TO-247 | |
| V_{DS} | Drain-source voltage ($V_{GS} = 0$) | 650 | | V |
| V_{GS} | Gate-source voltage | | ± 25 | V |
| I_D | Drain current (continuous) at $T_C = 25^\circ\text{C}$ | 12 ⁽¹⁾ | 12 | A |
| I_D | Drain current (continuous) at $T_C = 100^\circ\text{C}$ | 7.3 ⁽¹⁾ | 7.3 | A |
| $I_{DM}^{(2)}$ | Drain current (pulsed) | 48 ⁽¹⁾ | 48 | A |
| P_{TOT} | Total dissipation at $T_C = 25^\circ\text{C}$ | 90 | 25 | W |
| I_{AR} | Avalanche current, repetitive or non-repetitive (pulse width limited by T_j max) | | 4 | A |
| E_{AS} | Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$, $I_D = I_{AR}$, $V_{DD} = 50$ V) | | 200 | mJ |
| $dv/dt^{(3)}$ | Peak diode recovery voltage slope | | 15 | V/ns |
| V_{ISO} | Insulation withstand voltage (RMS) from all three leads to external heat sink ($t = 1$ s; $T_C = 25^\circ\text{C}$) | 2500 | | V |
| T_{stg} | Storage temperature | | - 55 to 150 | $^\circ\text{C}$ |
| T_j | Max. operating junction temperature | | 150 | $^\circ\text{C}$ |

1. Limited by maximum junction temperature
2. Pulse width limited by safe operating area
3. $I_{SD} \leq 12$ A, $di/dt \leq 400$ A/ μ s, $V_{DD} = 400$ V, $V_{Peak} < V_{(BR)DSS}$

Table 3. Thermal data

| Symbol | Parameter | Value | | | | | Unit |
|----------------|--|----------|--------------------|--------|------|--------|---------------------------|
| | | TO-220FP | I ² PAK | TO-220 | IPAK | TO-247 | |
| $R_{thj-case}$ | Thermal resistance junction-case max | 5 | | 1.38 | | | $^\circ\text{C}/\text{W}$ |
| $R_{thj-amb}$ | Thermal resistance junction-ambient max | | 62.5 | | 100 | 50 | $^\circ\text{C}/\text{W}$ |
| T_I | Maximum lead temperature for soldering purpose | | 300 | | | | $^\circ\text{C}$ |

2 Electrical characteristics

($T_C = 25^\circ\text{C}$ unless otherwise specified)

Table 4. On /off states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------|--|---|------|-------|----------|--------------------------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage ($V_{GS} = 0$) | $I_D = 1 \text{ mA}$ | 650 | | | V |
| I_{DSS} | Zero gate voltage drain current ($V_{GS} = 0$) | $V_{DS} = 650 \text{ V}$ $V_{DS} = 650 \text{ V}, T_C = 125^\circ\text{C}$ | | | 1 100 | μA μA |
| I_{GSS} | Gate-body leakage current ($V_{DS} = 0$) | $V_{GS} = \pm 25 \text{ V}$ | | | 100 | nA |
| $V_{GS(\text{th})}$ | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | 3 | 4 | 5 | V |
| $R_{\text{DS}(\text{on})}$ | Static drain-source on resistance | $V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$ | | 0.230 | 0.279 | Ω |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|--|---|---|------|-----------------|------|----------------|
| C_{iss} C_{oss} C_{rss} | Input capacitance Output capacitance Reverse transfer capacitance | $V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0$ | - | 1250 30 3 | - | pF pF pF |
| $C_{o(\text{tr})}^{(1)}$ | Equivalent capacitance time related | $V_{DS} = 0 \text{ to } 520 \text{ V}, V_{GS} = 0$ | - | 100 | - | pF |
| $C_{o(\text{er})}^{(2)}$ | Equivalent capacitance energy related | | - | 30 | - | pF |
| R_G | Intrinsic gate resistance | $f = 1 \text{ MHz}$ open drain | - | 2 | - | Ω |
| Q_g Q_{gs} Q_{gd} | Total gate charge Gate-source charge Gate-drain charge | $V_{DD} = 520 \text{ V}, I_D = 6 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see Figure 20) | - | 31 8 12 | - | nC nC nC |

1. $C_{\text{oss eq}}$ time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}
2. $C_{\text{oss eq}}$ energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 6. Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max | Unit |
|-------------------|--------------------|--|------|------|-----|------|
| $t_d(v)$ | Voltage delay time | $V_{DD} = 400 \text{ V}$, $I_D = 8 \text{ A}$, | | 25 | | ns |
| $t_r(v)$ | Voltage rise time | $R_G = 4.7 \Omega$, $V_{GS} = 10 \text{ V}$ | - | 7 | - | ns |
| $t_f(i)$ | Current fall time | (see <i>Figure 21</i>) | | 6 | - | ns |
| $t_c(\text{off})$ | Crossing time | (see <i>Figure 24</i>) | | 8 | - | ns |

Table 7. Source drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|---|------|------|------|---------------|
| I_{SD} | Source-drain current | | - | | 12 | A |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | | | 48 | A |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD} = 12 \text{ A}$, $V_{GS} = 0$ | - | | 1.5 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 12 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$ | | 300 | | ns |
| Q_{rr} | Reverse recovery charge | $V_{DD} = 100 \text{ V}$ (see <i>Figure 24</i>) | - | 3.5 | | μC |
| I_{RRM} | Reverse recovery current | | | 23 | | A |
| t_{rr} | Reverse recovery time | $I_{SD} = 12 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$ | | 350 | | ns |
| Q_{rr} | Reverse recovery charge | $V_{DD} = 100 \text{ V}$, $T_j = 150^\circ\text{C}$ | - | 4 | | μC |
| I_{RRM} | Reverse recovery current | (see <i>Figure 24</i>) | | 24 | | A |

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220FP

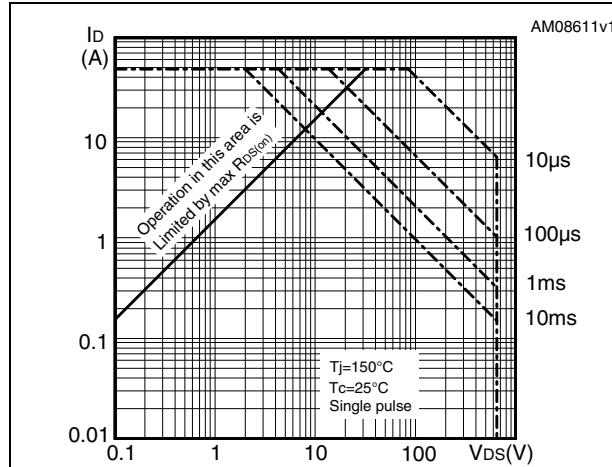


Figure 3. Thermal impedance for TO-220FP

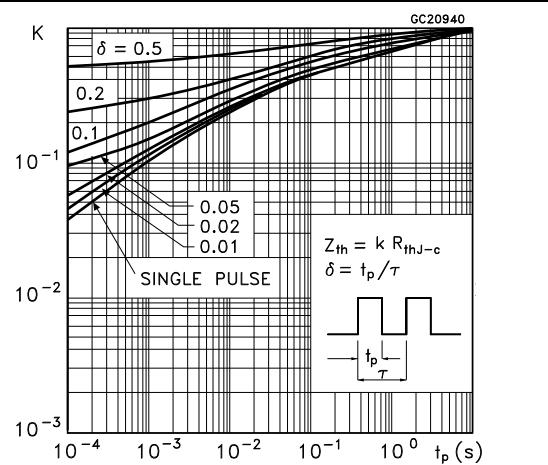
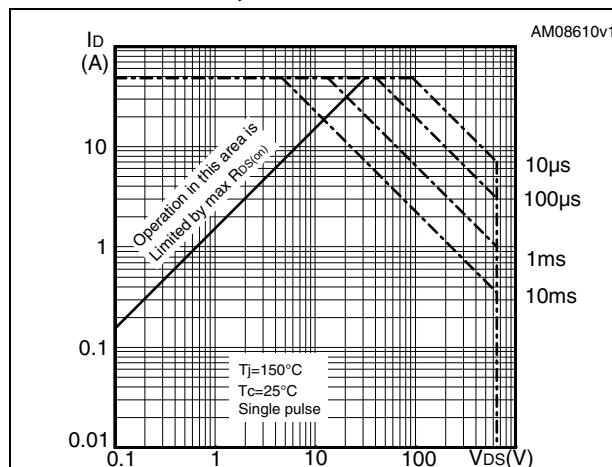
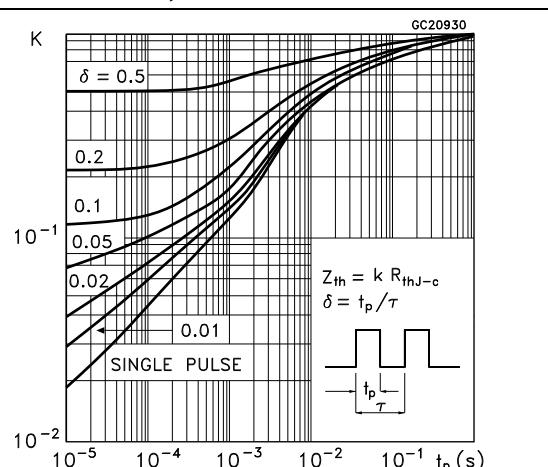
Figure 4. Safe operating area for TO-220, I²PAK, TO-247Figure 5. Thermal impedance for TO-220, I²PAK, TO-247

Figure 6. Safe operating area for IPAK

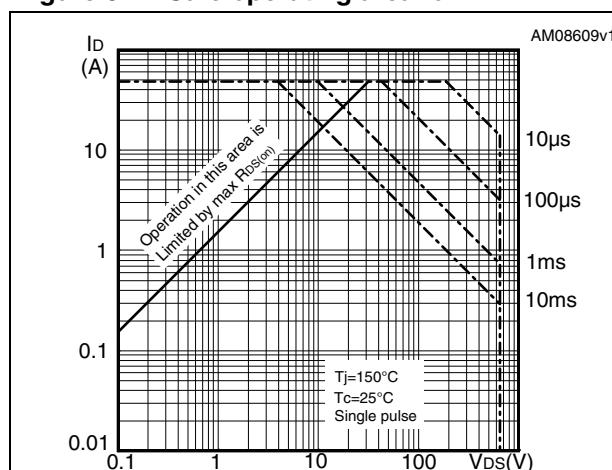


Figure 7. Thermal impedance for IPAK

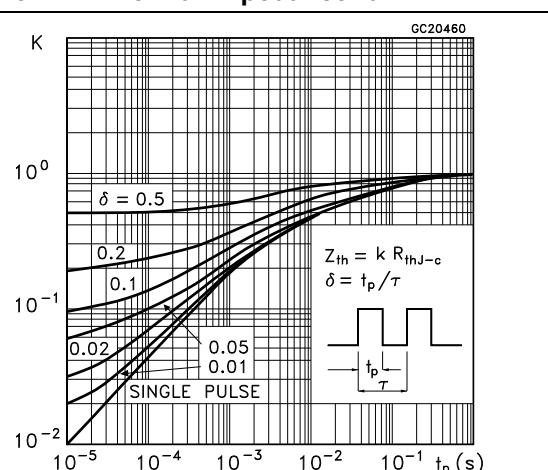


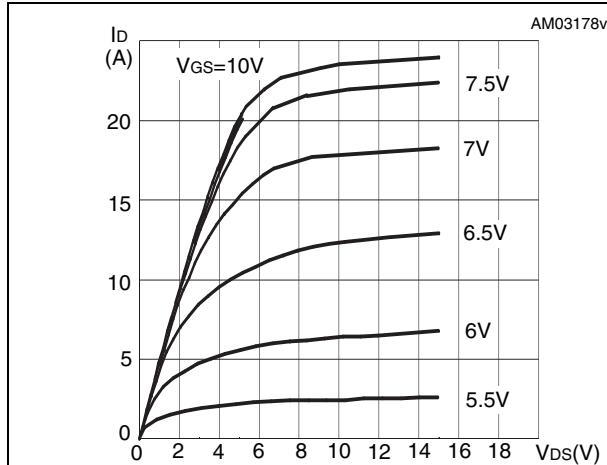
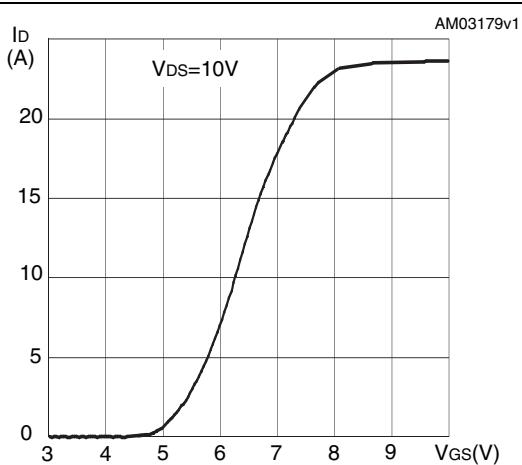
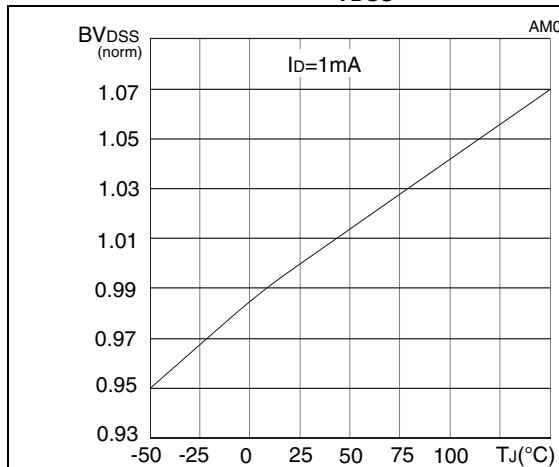
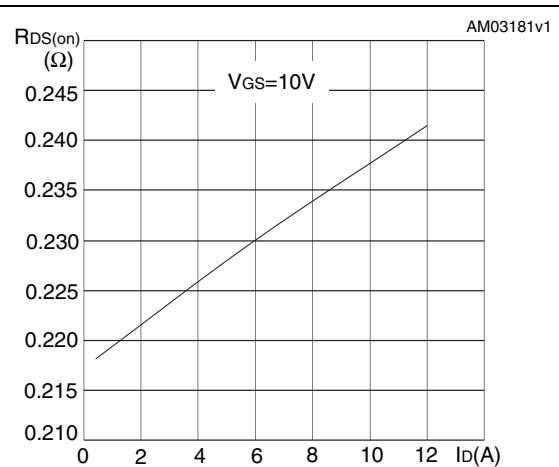
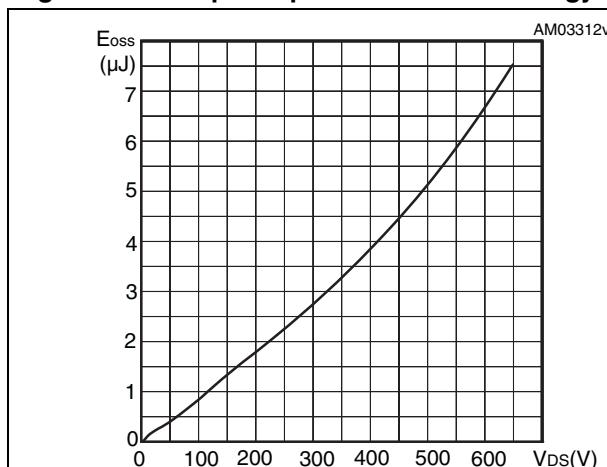
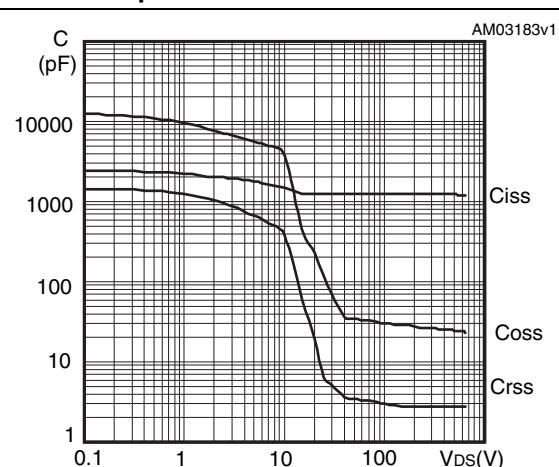
Figure 8. Output characteristics**Figure 9. Transfer characteristics****Figure 10. Normalized B_{VDSS} vs temperature****Figure 11. Static drain-source on resistance****Figure 12. Output capacitance stored energy****Figure 13. Capacitance variations**

Figure 14. Gate charge vs gate-source voltage **Figure 15. Normalized on resistance vs temperature**

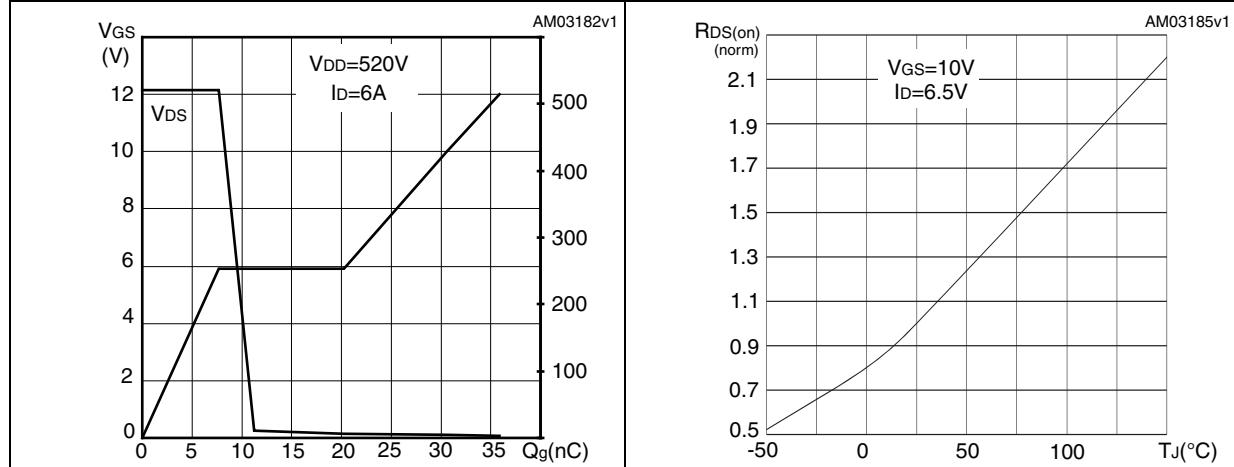


Figure 16. Normalized gate threshold voltage vs temperature

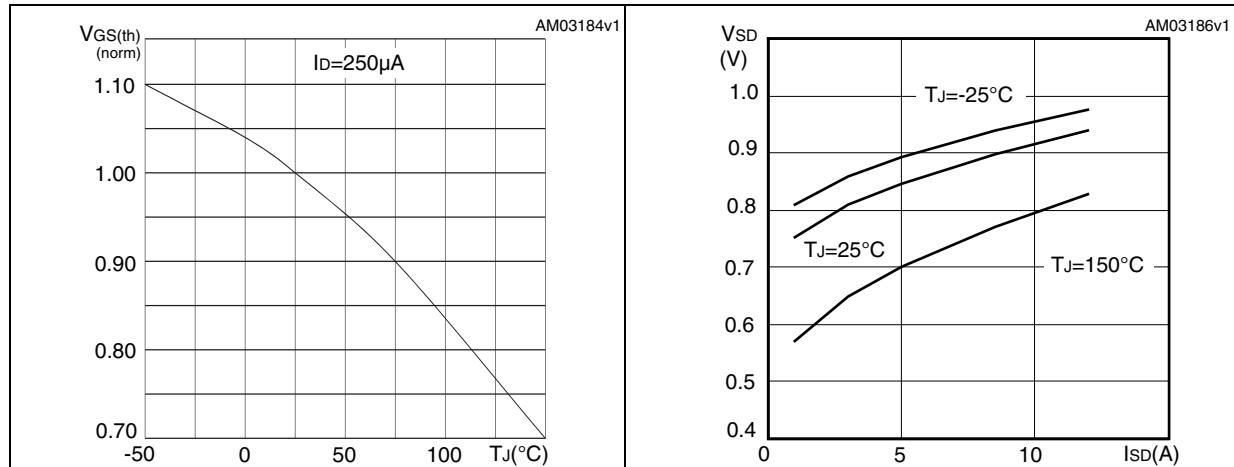
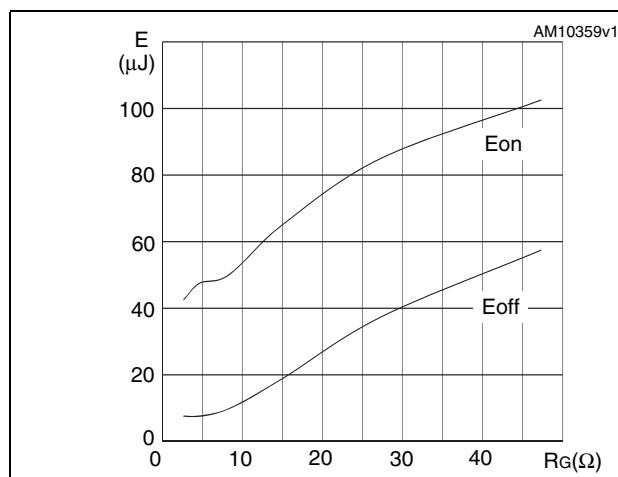


Figure 18. Switching losses vs gate resistance (1)



1. Eon including reverse recovery of a SiC diode

3 Test circuits

Figure 19. Switching times test circuit for resistive load

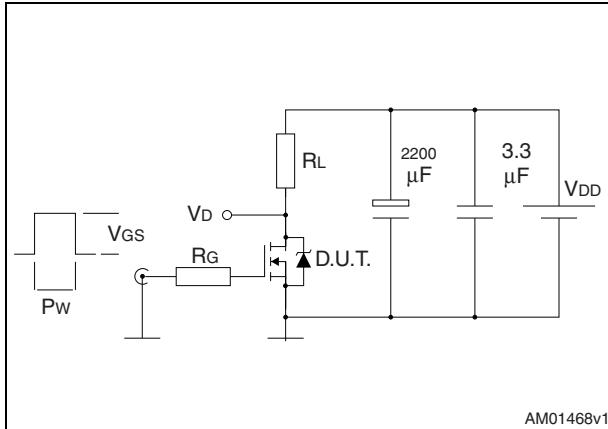


Figure 20. Gate charge test circuit

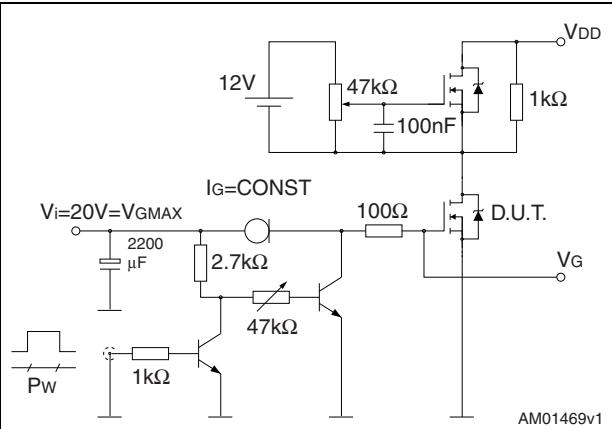


Figure 21. Test circuit for inductive load switching and diode recovery times

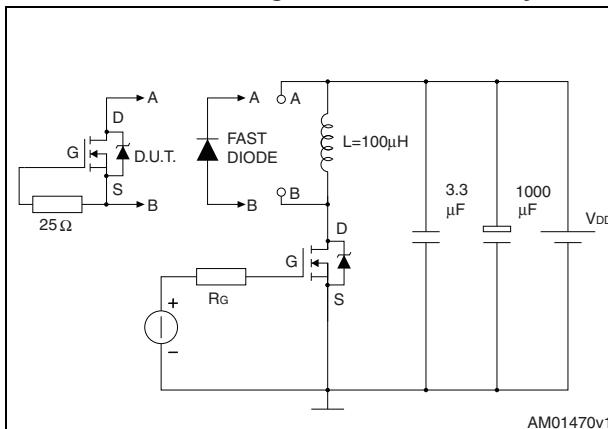


Figure 22. Unclamped inductive load test circuit

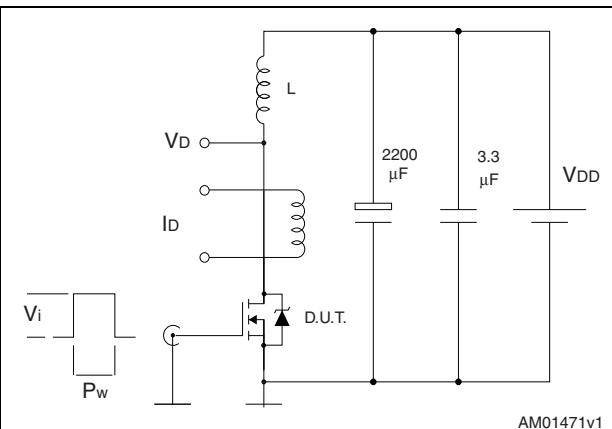


Figure 23. Unclamped inductive waveform

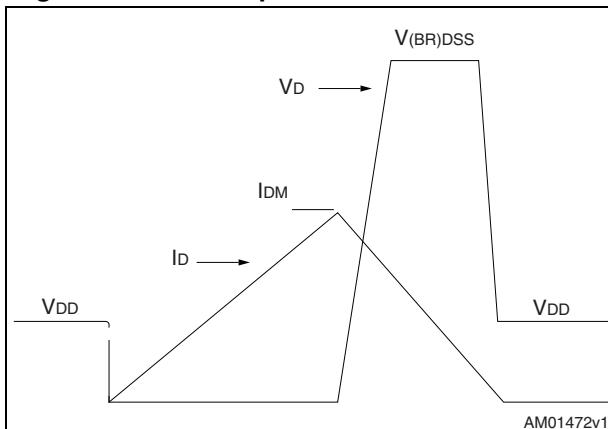
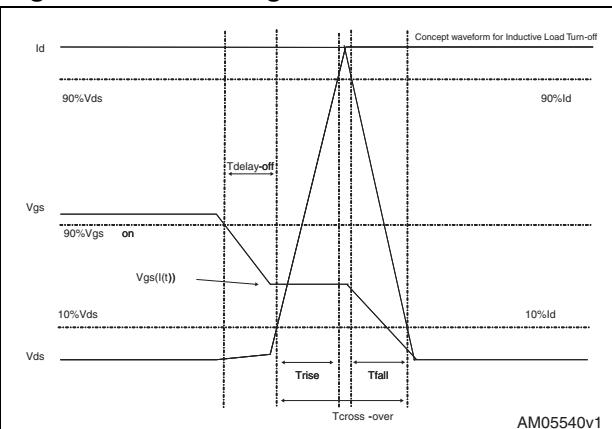


Figure 24. Switching time waveform

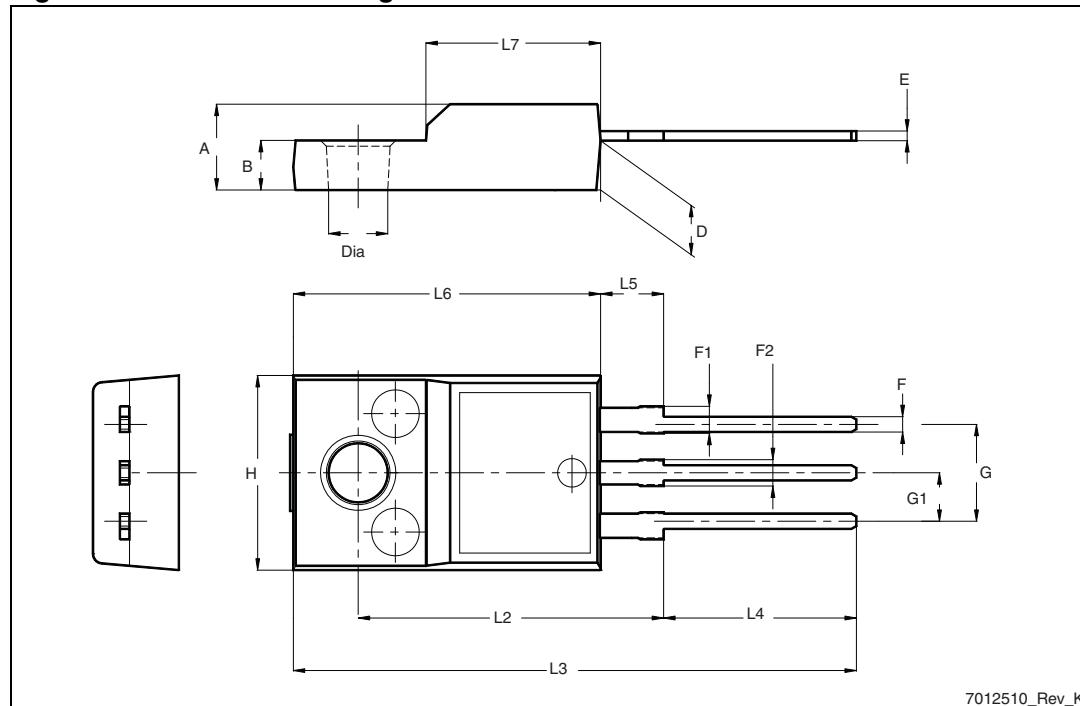


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. TO-220FP mechanical data

| Dim. | mm | | |
|------|------|------|------|
| | Min. | Typ. | Max. |
| A | 4.4 | | 4.6 |
| B | 2.5 | | 2.7 |
| D | 2.5 | | 2.75 |
| E | 0.45 | | 0.7 |
| F | 0.75 | | 1 |
| F1 | 1.15 | | 1.70 |
| F2 | 1.15 | | 1.70 |
| G | 4.95 | | 5.2 |
| G1 | 2.4 | | 2.7 |
| H | 10 | | 10.4 |
| L2 | | 16 | |
| L3 | 28.6 | | 30.6 |
| L4 | 9.8 | | 10.6 |
| L5 | 2.9 | | 3.6 |
| L6 | 15.9 | | 16.4 |
| L7 | 9 | | 9.3 |
| Dia | 3 | | 3.2 |

Figure 25. TO-220FP drawing

7012510_Rev_K

Table 9. I²PAK (TO-262) mechanical data

| DIM. | mm. | | |
|------|------|-----|-------|
| | min. | typ | max. |
| A | 4.40 | | 4.60 |
| A1 | 2.40 | | 2.72 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| c | 0.49 | | 0.70 |
| c2 | 1.23 | | 1.32 |
| D | 8.95 | | 9.35 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| E | 10 | | 10.40 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L2 | 1.27 | | 1.40 |

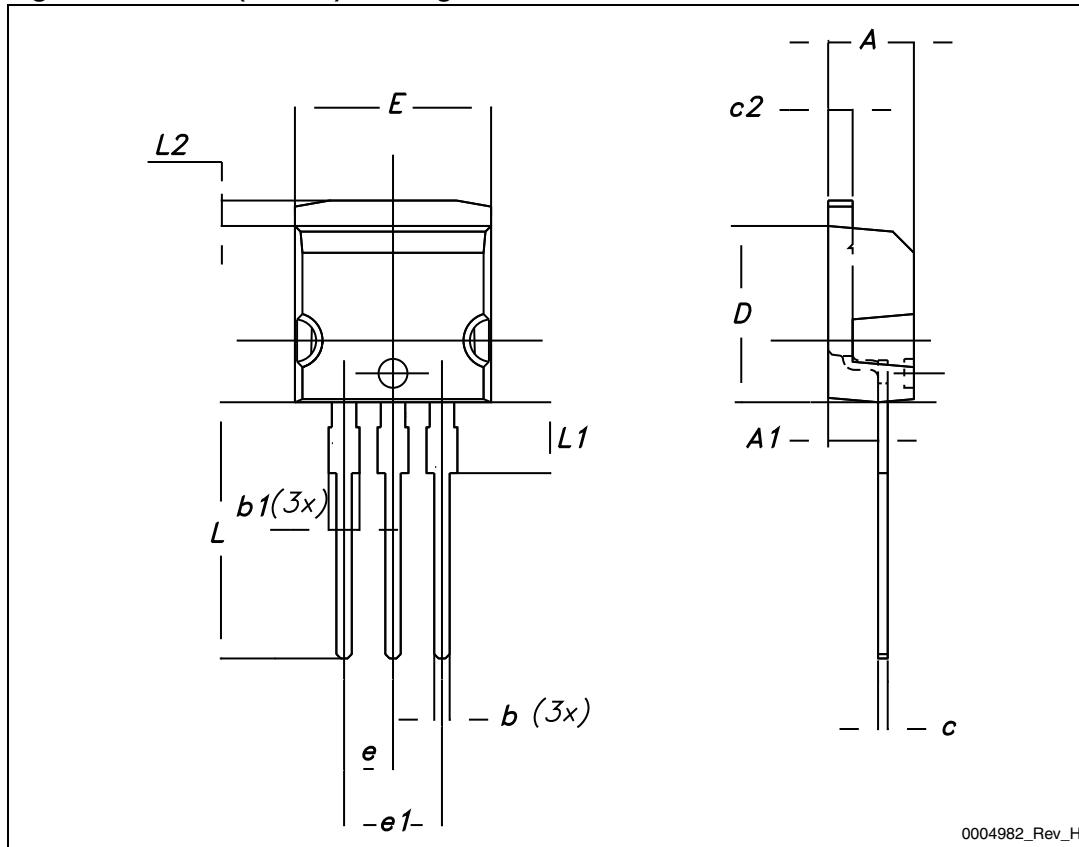
Figure 26. I²PAK (TO-262) drawing

Table 10. TO-220 type A mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| c | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10 | | 10.40 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| ØP | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

Figure 27. TO-220 type A drawing

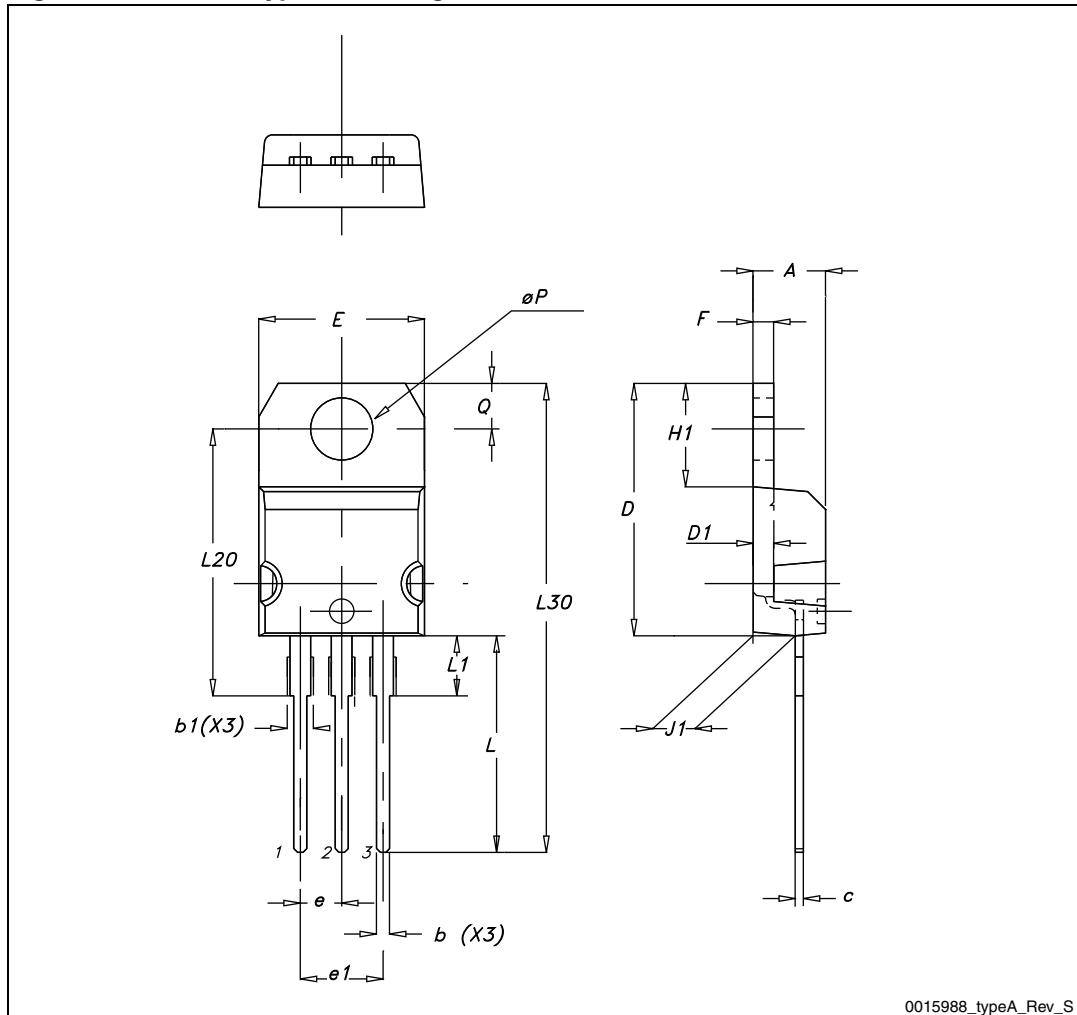


Table 11. IPAK (TO-251) mechanical data

| DIM. | mm. | | |
|------|------|-------|------|
| | min. | typ | max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| b | 0.64 | | 0.90 |
| b2 | | | 0.95 |
| b4 | 5.20 | | 5.40 |
| B5 | | 0.3 | |
| c | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| E | 6.40 | | 6.60 |
| e | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| H | | 16.10 | |
| L | 9.00 | | 9.40 |
| L1 | 0.80 | | 1.20 |
| L2 | | 0.80 | 1.00 |
| V1 | | 10 ° | |

Figure 28. IPAK (TO-251) drawing

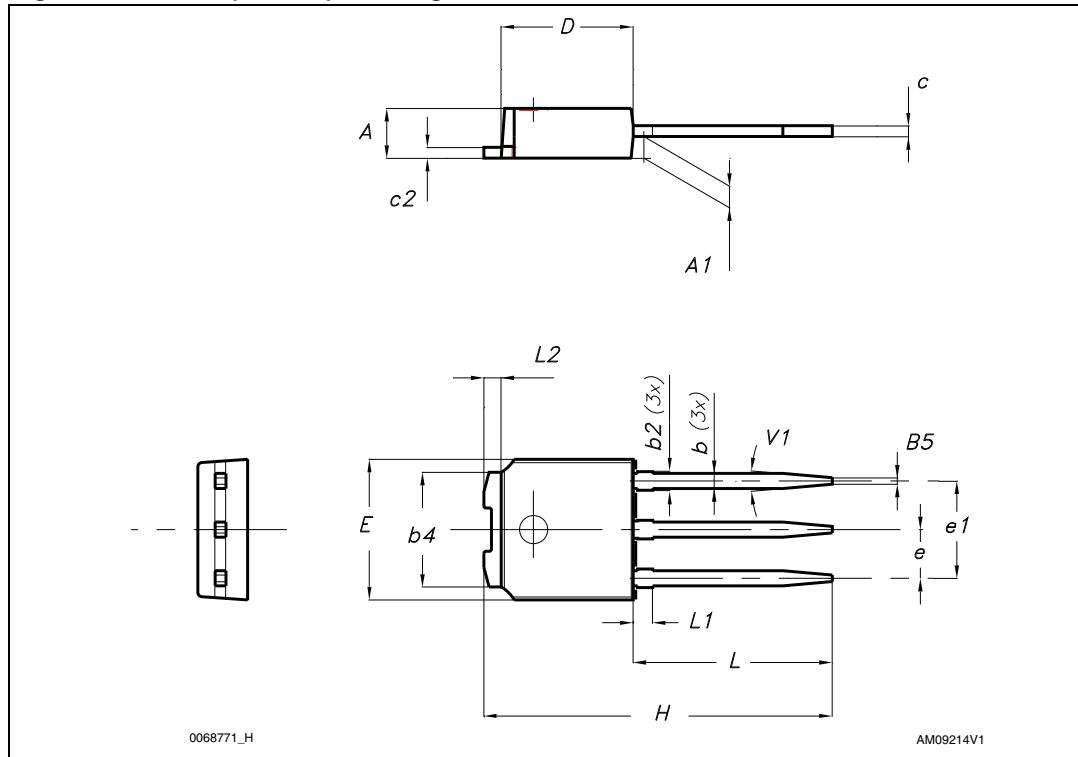
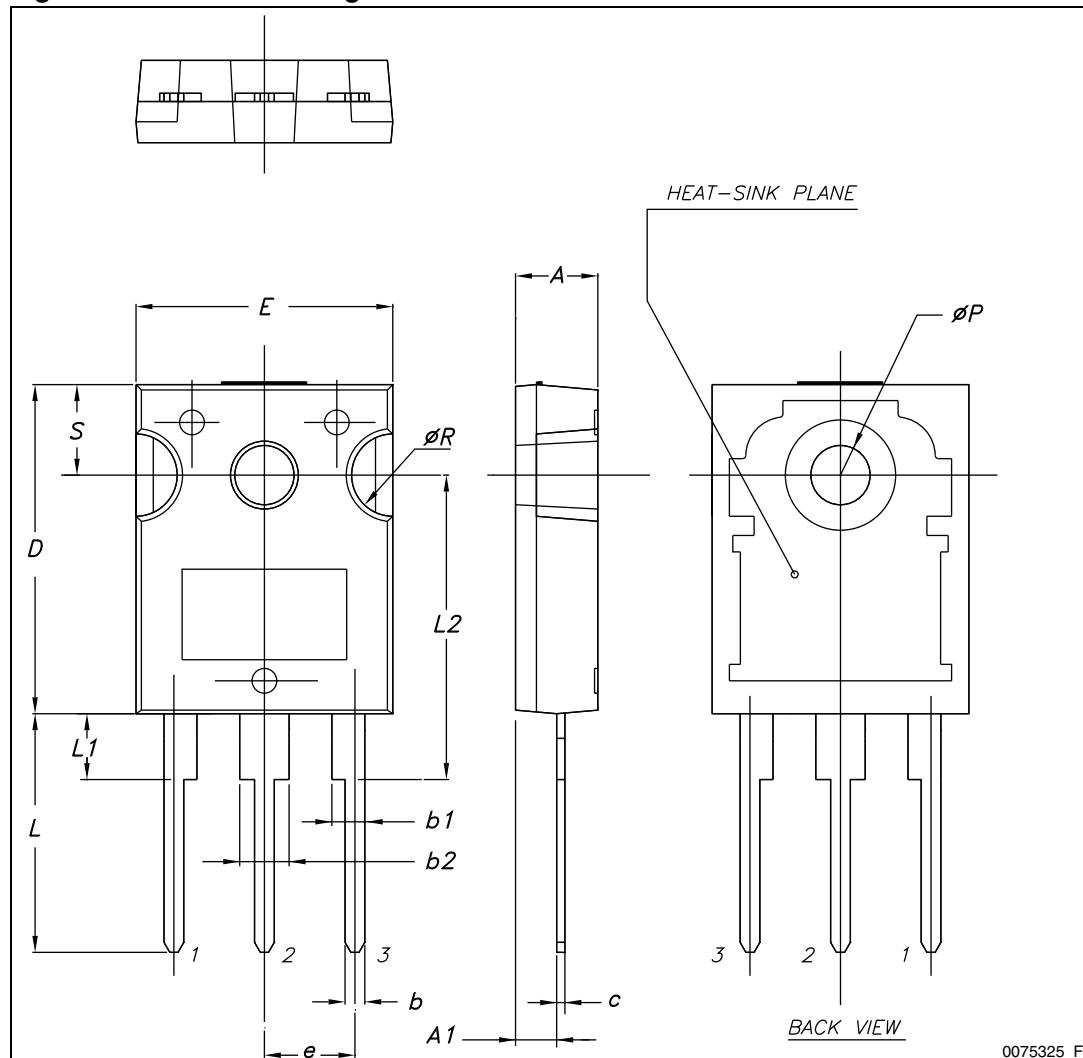


Table 12. TO-247 mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.85 | | 5.15 |
| A1 | 2.20 | | 2.60 |
| b | 1.0 | | 1.40 |
| b1 | 2.0 | | 2.40 |
| b2 | 3.0 | | 3.40 |
| c | 0.40 | | 0.80 |
| D | 19.85 | | 20.15 |
| E | 15.45 | | 15.75 |
| e | | 5.45 | |
| L | 14.20 | | 14.80 |
| L1 | 3.70 | | 4.30 |
| L2 | | 18.50 | |
| ØP | 3.55 | | 3.65 |
| ØR | 4.50 | | 5.50 |
| S | | 5.50 | |

Figure 29. TO-247 drawing



5 Revision history

Table 13. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 12-Feb-2009 | 1 | First release. |
| 21-Oct-2010 | 2 | <ul style="list-style-type: none">– Document status promoted from preliminary data to datasheet.– Added new package, mechanical data: I²PAK.– Removed DPAK, D²PAK packages and mechanical data. |
| 10-Feb-2011 | 3 | Modified R _{DS(on)} value (see Table 4 and Figure 11). Modified Section 2.1: Electrical characteristics (curves) : <ul style="list-style-type: none">– Figure 8, Figure 9, Figure 10, Figure 11, Figure 15 and Figure 16– Added Figure 18 Updated R _{DS(on)} value in Table 4 Updated values in Table 6 Minor text changes. |
| 13-Oct-2011 | 4 | |

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[FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#) [NTE221](#) [NTE2384](#) [NTE2903](#) [NTE2941](#) [NTE2945](#) [NTE2946](#) [NTE2960](#) [NTE2967](#)
[NTE2969](#) [NTE2976](#) [NTE455](#) [NTE6400A](#) [NTE2910](#) [NTE2916](#) [NTE2956](#) [NTE2911](#) [DMN2080UCB4-7](#) [TK10A80W,S4X\(S](#)
[SSM6P69NU,LF](#) [DMP22D4UFO-7B](#) [DMN1006UCA6-7](#)